

SB340(E)(H) ~ SB3200(E)(H)

Power Schottky Rectifier - 3Amp 40~200Volt

Features

-Low forward voltage drop

-High current capability

-High reliability

-High surge current capability

-Epitaxial construction

Mechanical data

-Case: Molded plastic

-Epoxy: UL 94V-0 rate flame retardant

-Lead: Axial leads, solderable per MIL-STD-202, method 208 guaranteed

-Polarity: Color band denotes cathode end

-Mounting position: Any -Weight: 1.2 grams

■ Maximum ratings and Electrical characteristics

| Parameters (Note 1) | | SB340(E)(H) | SB360(E)(H) | SB3100(E)(H) | SB3150(E)(H) | SB3200(E)(H) | UNIT |
|--|------------|-------------|-------------|--------------|--------------|--------------|------|
| Maximum Recurrent Peak Reverse Voltage | | 40 | 60 | 100 | 150 | 200 | V |
| Maximum RMS Voltage | | 28 | 42 | 70 | 105 | 140 | V |
| Maximum DC Blocking Voltage | | 40 | 60 | 100 | 150 | 200 | V |
| Maximum Average Forward Rectified Current | | 3 | | | | | Α |
| Peak Forward Surge Current | | 80 | | | | | Α |
| Maximum Instantaneous Forward Voltage at 3A | Tc = 25°C | 0.55 | 0.65 | 0.82 | 0.88 | 0.90 | V |
| | Tc = 125°C | 0.50 | 0.55 | 0.66 | 0.69 | 0.72 | |
| Maximum Average Reverse Current at Rated DC Blocking Voltage | Tc = 25°C | 0.5 | | 0.05 | | | mA |
| | Tc = 100°C | 20 10 | | | | | |
| Typical Junction Capacitance | | 150 | | | | | pF |
| Typical Thermal Resistance ReJA (Note 2) | | 30 | | | | | °C/W |
| Operating and Storage Temperature Range | | -50 to +125 | | -50 to +150 | | | °C |

Note: 1. E means Alloy, H means Halogen-Free

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^{2.} Mounted on P.C.B with copper pad size 16mm x 16mm, vertical P.C.B 9.5mm lead lengths

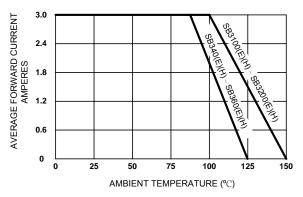


Figure 1. Forward Current Derating Curve

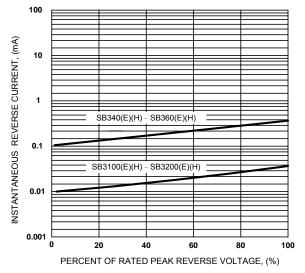


Figure 3. Typical Reverse Characteristics

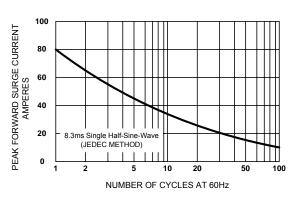


Figure 2. Maximum Non-repetitive Surge Current

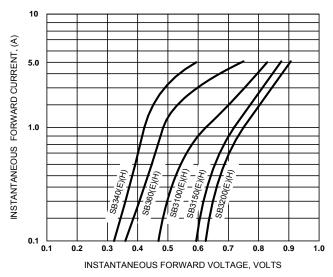


Figure 4. Typical Forward Characteristics

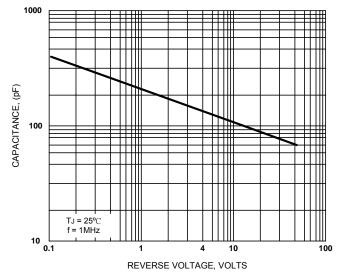
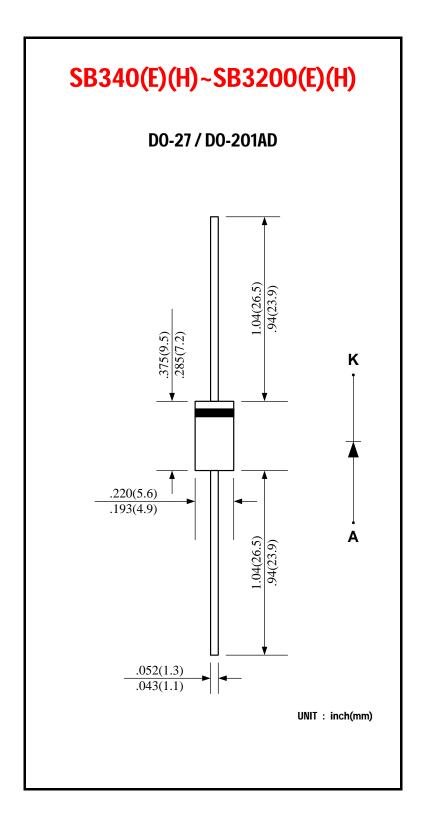


Figure 5. Typical Junction Capacitance





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